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# XR829MQ Module Datasheet

Single-Chip IEEE 802.11 b/g/n WLAN, Bluetooth 2.1/4.0/4.1

Wersion 1.0
August 13, 2018

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# **Revision History**

Version	Date	Notes	e till the	E HILL
V1.0	August.13, 2018	Initial Version	11,	1/10

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# 1 Introduction

XR829MQ product is designed base on XR829 chipset .It is a fully integrated SoC to support 2.4G WLAN 802.11 b/g/n and Bluetooth 2.1+EDR/4.1. It is optimized for mobile applications such as PDAs and portable media players. High sensitivity and transmitting power ensure long distance and robust connection. Highest level of integration allows very compact and cost effective reference designs delivering fast time-to-market for new WLAN and Bluetooth enabled products.

### 2 Features

#### 2.1 WLAN Features

- Compatible with IEEE 802.11 b/g/n standard
- 802.11n support for 20/40MHz bandwidth
- Support for Short Guard Interval
- Support for 802.11n MCS0~MCS7
- 6M~54M data rate for 802.11g
- DSSS, CCK modulation with long and short preamble
- Support frame aggregation using A-MSDU, A-MPDU
- Supports MAC enhancements including
  - 802.11d Regulatory domain operation
  - 802.11e QoS including WMM
  - 802.11h Transmit power control dynamic and frequency selection
  - 802.11i Security including WPA2 and WAPI compliance
  - 4802.11r Roaming
  - 802.11w Management frame protection
- Support for Station, SoftAP and P2P mode
- Support for Wi-Fi Direct

#### 2.2 Bluetooth Features

- Bluetooth Dual Mode support with 2.1/4.0/4.1
- Class 1, Class 2 and Class 3 transmitter operation
- Host Controller Interface using a high-speed UART, maximum baud rate of 4 Mbps
- Adaptive Frequency Hopping
- SCO and eSCO support
- 1, 3 and 5 slots all packet types support
- Audio interfaces: PCM, I2S
- Transcoders for A-law, µ-law and CVSD voice over air

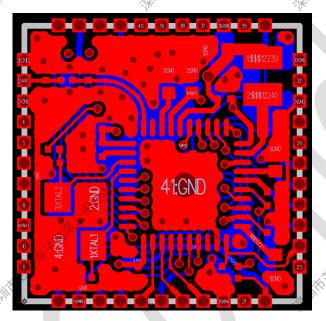


- Piconet and scatternet support
- Secure simple pairing
- Sniff/Hold/Sniff-Sub-rating low power mode support

# 3 Applications

- Tablet PC
- Smart internet TV box
- Portable media player(PMP)
- Portable gaming device(PGD)
- Internet of Thing (IOT)

# 4 Product appearance



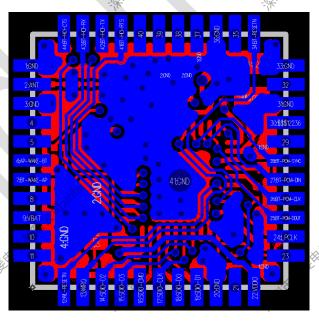
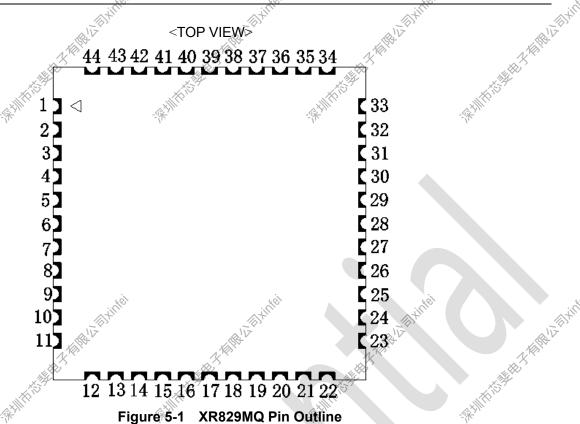


Figure 4-1 XR829MQ Top and Bottom View

# 5 Pin Assignments

#### 5.1 Pin Outline





### 5.2 Pin Definition

Table 5-1 XR829MQ Pin List

P	in	Name	Туре	Description
1		GND1	-	Ground connetctions
2		ANT	I/O	2.4 GHz RF input/output
3		GND2	intel is	Ground connetctions
4	BRIVE	NC1	-	Floating(Don't connected to ground)
5	X	NC2	-	Floating(Don't connected to ground)
6		BT-WAKE	1 ((K))	Host wakes up Bluetooth subsystem
7		BT-HOST-WAKE	O ****	Bluetooth subsystem wakes up host
8		NC3	-	Floating(Don't connected to ground)
9		VBAT	Р	Supply for on-chip-PMU
1	0	NC4	ı	Floating(Don't connected to ground)
1	1	NC5	-	Floating(Don't connected to ground)
1:	2	WL-REG-ON	I	WLAN Reset, active low
1	3	WL-HOST-WAKE	0	WLAN interrupt request
1	4	\$DIO-DATA2	MO	SDIO data line2
1	186	SDIO-DATA3	I/O	SDIQ data line3
1	6	SDIO-DATA-CMD	I/O	SDIO command line



//	till.	till.	Atill.
17	SDIO-DATA-CLK	Ì	SDIO clock line
18	SDIO-DATA-DATA0	I/O	SDIO data line0
19	SDIO-DATA-DATA1	I/O (1/5) <sup>3/9</sup>	SDIO data line1
20	GND3	- · · · · · · · · · · · · · · · · · · ·	Ground connetctions
21	NC6	-	Floating(Don't connected to ground)
22	VDDIO	Р	Supply for IO
23	NC7	-	Floating(Don't connected to ground)
24	LPO	I	Low power clock input, 32.768 kHz, or be grounded
25	PCM-OUT	0	Bluetooth PCM data output
26	PCM-CLK	I/O	Bluetooth PCM clock
27	PCM-IN	<i>ii</i>	Bluetooth PCM data input
28	PCM-SYNC	I/O	Bluetooth PCM synchronization control
29	NC8	-	Floating(Don't connected to ground)
30	TCXO-IN	I stillfind	Reference clock input or XTAL inputs
31	GND4	- 7/4	Ground connetctions
32	NC9	-	Floating(Don't connected to ground)
33	GND5	-	Ground connetctions
34	BT-RST-N	I	Bluetooth Reset, active low
35	NC10	-	Floating(Don't connected to ground)
36	GND6	-	Ground connetctions
37	NC11	idei	Floating(Don't connected to ground)
38	NC12	-	Floating(Don't connected to ground)
39	NC13	-	Floating(Don't connected to ground)
40	NC14	-	Floating(Don't connected to ground)
41	UART-RTS-N	O \$\frac{1}{2}\frac{1}{2}\frac{1}{2}	Bluetooth Uart RTS
42	UART-TXD	0	Bluetooth Uart transmit
43	UART-RXD	I	Bluetooth Uart receive
44	UART-CTS-N	I	Bluetooth Uart CTS

# 6 General Specification

## 6.1 General Specification



Table 6-1	XR829MQ	Module	general S	Specification	ì

		√ ·
Item	Description	***
Product Name	XR829MQ	
Major Chipset	XR829	-\$\frac{1}{2}\frac{1}{
Product Description	Support WiFi/Bluetooth functionalities	,
Dimension(L*W*H)	12 x12x 1.5mm (LxWxH); Tolerance: +-0.1mn	n
Working Temperature	-40°C ~ +85°C	
Storage temperature	-55°C ~ +125°C	

### 6.2 Voltages

### 6.2.1 Absolute Maximum Ratings

Table 6-2 Absolute Maximum Rating

Symbol	Parameter A	A A A A A A A A A A A A A A A A A A A	Min	Max	Unit
VBAT	Power supply for module		-0.3	5.8	V
VDDIO	IO power supply	i i i i i i i i i i i i i i i i i i i	-0.3	4.0	Ville

#### 6.2.2 Recommended Operating Rating

The module requires two power supplies: VBAT and VDDIO

**Table 6-3 Recommended Operating Rating** 

Symbol	Parameter	Min	Тур	Max	Unit
VBAT	Power supply for module	2.7	3.6	5.5	V
VDDIO	IO power supply	1.62	3.3	3.6	V



## 7 Clocks

XR829 uses a reference clock and a low power clock.

For the reference clock, XR829 can either use an external reference clock source or generate its own reference using a XTAL and a built-in oscillator.

For the low power clock, XR829 can either use an external 32.768 KHz clock or generate its internal RCOSC. If use internal RCOSC, the LPCLK pin should be grounded. The low power clock is used during power save modes and used only for power controller module.

#### 7.1 Reference Clock

Table 7-1 External Reference Clock Specifications

Symbol	Parameter	Min	Typ	Max	Unit
FIN	Clock input frequency list using an external clock source	13	24	52	MHz
I IIV	Clock input frequency list using a XTAL and the built-in oscillator	19.2	24	52	MHz
F <sub>INTOL</sub>	Tolerance on input frequency without trimming	-20	-	+20	ppm
T <sub>stable</sub>	Clock stabilization time	-		10	ms
ILEAK	Input leakage current, both for analog and digital	-	-	1	uA

#### **Clock frequency detection**

An integrated automatic detection algorithm detects the reference clock frequency using the low power clock after a hardware reset.

#### Clock source detection

An integrated automatic detection mechanism detects the clock source from the connections of the XTAL1 and XTAL2 pins:

- When an external reference clock source is used, the clock input pin is XTAL2. The XR829 supports both an analog and digital source. An analog source shall be AC coupled to XTAL2 while a digital source shall be DC coupled to XTAL2. In both cases, XTAL1 shall be DC grounded.
- When a XTAL and the built-in oscillator are used, the XTAL shall be DC coupled to XTAL1 and XTAL2.

#### **External Clock Source**

Requirements

Table 7-2 External Clock Requirements

Symbol	Parameter	Min	Тур	Max	Unit
AC coupled signal					
Fin	Frequency	13	24	52	MHz
VAPP	Peak-to-peak voltage range of the AC coupled	0.4	0.5	1.2	Vpp
RIVE	analog input		BAIL	Y	//
NH	Total harmonic content of the input signal	-	- **	-25	dBc



_	///				(2)	
	OC couple	ed signal		SELV	<i>?</i> *	_
Ŋ	/11/2	input low voltage on XTAL2	0	- **	0.3*V18	V , 1, 1
X	<b>7</b> ін	input low voltage on XTAL2	0.7*V18	(A)	V18	V
T	Γ <sub>r</sub> /T <sub>f</sub>	10%-90% rise and fall time		-	5	ns
	Outy cycle	Cycle-to-cycle	40	50	60	%
E	Both anal	og and digital signals				
Z	ZINRE	Real part of parallel AC input impedance at the pin	30	-	-	KOhm
Z	ZINIM	Imaginary part of parallel AC input impedance at the pin	-	3.5	5	pF
Z	ZDC	DC input impedance	(ंगे	-	-Intel	MOhm
F	Phase noise	Ref clock @ 24 MHz, 2.4 GHz 802.11b/g/n operation @1 kHz @100 kHz @100 kHz		A A A A A A A A A A A A A A A A A A A	-123 -133 -138	dBc/Hz

#### **External XTAL and Built-in Oscillator**

**Table 7-3 External Crystal Characteristics Requirements** 

Parameter	Conditions	Min	Тур	Max	Unit
Frequency range		13	-	52	MHz
ESR		-	-	60	Ohm
Cin_xtal <sup>(1)</sup>	Single-ended	3.5	18	<sub>.</sub> 36	pF
Load capacitance <sup>(1)</sup>	A LIZ	-	16. Or	27	pF
Oscillator tuning range <sup>(2)</sup>		+/-20	+7-50	+/-70	ppm
Crystal frequency accuracy at nominal	25 °C	-10	-	+10	ppm
temperature	, 1	Kin .		7)	H. Kritz
Crystal drift due to temperature	-20 °C to +85 °C 🏋	-10	-	+10 🎋	ppm
Crystal pull ability		10	-	150	ppm/pF

<sup>(1).</sup> The load capacitance value ( $C_{load}$ ) depends on XTAL model, XTAL1 and XTAL2 pin have extra capacitance( $C_{in\_xtal}$ ), so external added load capacitance value  $C_{load\_ext}$ = $C_{load}$ - $C_{in\_xtal}$ .  $C_{in\_xtal}$  has tuning range about 7pF, which is controlled by software, for details please go to software user manual.

#### 7.2 Low Power Clock

Table 7-4 Low Power Clock Specifications

Symbol	Parameter	Min	Тур	Max	Unit

<sup>(2).</sup> Tuning range depends on XTAL load capacitance requirement, typical case is based on 26MHz XTAL,  $8pF\ C_{load}$ .



				AT.	
FIN NOTE OF	Frequency	-	32.768	A LV	KHz
F/Fin	Frequency accuracy	-250	- **	+250	ppm
Duty cycle		30	-	70	<b>%</b>
Jitter	Cycle-to-cycle	-40		+40	ns
Rin	Input resistance	1	-	-	MOhm
Cin	Input capacitance	-	-	5	pF
VIL	Input low voltage on LPCLK	0	-	0.4	٧
VIH	Input high voltage on LPCLK	VDD_IO- 0.4	-	VDD_IO	٧



# 8 WLAN Specification

Conditions: VBAT=3.6V; VDDIO=3.3V; Temp:25° C

Table 8-1 Wi-Fi RFSpecification

	rable 6-1 Wi-Fi Krapecilication
Parameter	Description
Host Interface	SDIO 2.0
Standard	IEEE 802.11b,IEEE 802.11g,IEEE 802.11n
Frequency range	2.412GHZ~2.484GHZ
Modulation Type	802.11b: CCK,DQPSK,DBPSK
in <sup>tol</sup>	802.11g/n: 64-QAM,16-QAM,QPSK,BPSK
Data Transfer Rate	1,2,5.5,6,11,12,18,22,24,30,36,48,54,SGI/HT40,65Mbps
RX Sensitivity (802.11b)	1Mbps PER@-97dBm,typical
@8% PER	2Mbps PER@-95dBm,typical
深圳市	5.5Mbps PER@-93dBm,typical
	11Mbps PER@-90dBm,typical
RX Sensitivity (802.11g)	6Mbps PER@-92dBm,typical
@10% PER	9Mbps PER@-92dBm,typical
	12Mbps PER@-91dBm,typical
	18Mbps PER@-88dBm,typical
	24Mbps PER@-86dBm,typical
A STATE OF THE PARTY OF THE PAR	36Mbps PER@-82dBm,typical
ALIV A	48Mbps PER@-78dBm_typical
A TOP TO THE PROPERTY OF THE P	54Mbps PER@-76dBm,typical
RX Sensitivity	MCS0 PER@-91dBm,typical
(802.11n,20MHz)	MCS1 PER@-87dBm,typical
@10% PER	MCS2 PER@-85dBm,typical
	MCS3 PER@-83dBm,typical
	MCS4 PER@-79dBm,typical
	MCS5 PER@-75dBm,typical
	MCS6 PER@-74dBm,typical
	MCS7 PER@-72dBm,typical
RX Sensitivity	MCS0 PER@-89dBm,typical
(802.11n,40MHz)	MCS1 PER@-87.5dBm,typical
@10% PER	MCS2 PER@-84.5dBm,typical
100 100 100 100 100 100 100 100 100 100	



At	A+	At.	^~	t.
A THE TOTAL SECTION ASSESSMENT OF THE PARTY	MCS3	PER@-81.5dBm,typical	RIVE IN	,
	MCS4	PER@-78dBm,typical	A A A A A A A A A A A A A A A A A A A	
	MCS5	PER@-74dBm,typical	WHI THE	
-1/k	MCS6	PER@-72dBm,typical	***	****
	MCS7	PER@-71dBm,typical		
Maximum Input Level	802.11b: -	-10dBM		
	802.11g/n:	-20dBM		
TX Power	802.11b/11	Mbps: 16dBm±1.5dB@	)EVM≦-9dB	
	802.11g/54	HMbps: 15dBm±1.5dB@	EVM≦-25dB	
نف	802.11n/64	المالة HMbps: 14dBm±1.5dB @I	EVM≦-28dB	(6)

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# 9 Bluetooth Specification

Conditions: VBAT=3.6V; VDDIO=3.3V; Temp:25° C

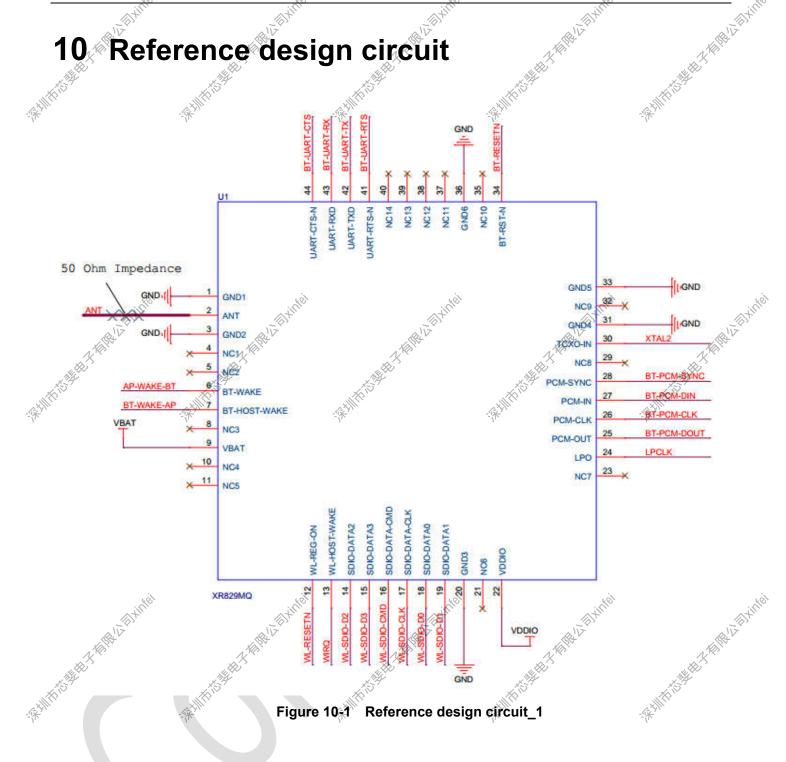
**Table 9-1 Bluetooth Specification** 

Parameter	Description
Host Interface	UART/PCM
Standard	Bluetooth 2.1/4.0/4.1
Frequency range	2.402GHZ~2.480GHZ
Modulation Type	GFSK, π/4-DQPSK,8DPSK,GFSK
RX Sensitivity (BR)	1Mbps GFSK: -91dBm,typical
RX Sensitivity (EDR)	2Mbps π/4-DQPSK: -93dBm,typical
	3Mbps 8DPSK: -85dBm,typical
RX Sensitivity (BLE)	1Mbps GFSK : -93dBm,typical
TX Power	Class1, Class2, Class3@BR, EDR: -17~7dBm;
	BLE: 7dBm.
Maximum Input Level	1Mbps GFSK: -20dBm
	2Mbps π/4-DQPSK: -20dBm
	3Mbps 8DPSK: -10dBm

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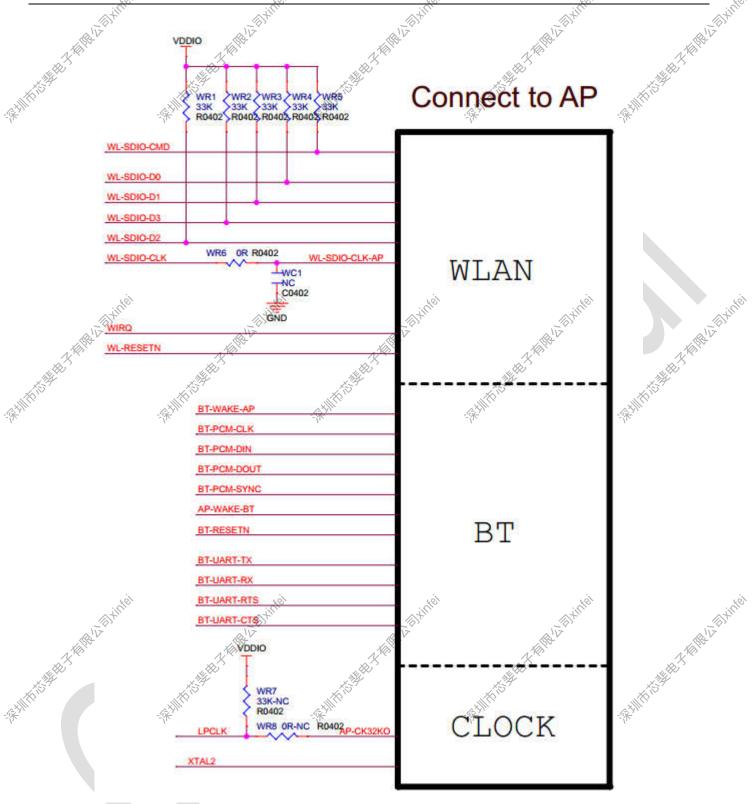


Figure 10-2 Reference design circuit\_2

#### design note:

- 1. The impedance of ANT line must be 50 ohm.
- 2. The voltage supplied through the pin VBAT should between 2.7V-5.5V.
- 3. SDIO line cannot be longer than 150mm.
- 4. VCCIO voltage to be consistent with the HOST I/O voltage between 1.62V-3.6V



# 11 Dimensions

### 11.1 Physical Dimensions

**Table 11-1 Physical Dimensions** 

	Length	Width	Height
Dimensions/mm)	12	12	1.5
Dimensions(mm)	(Tolerance:±0.1mm)	(Tolerance:±0.1mm)	(Tolerance:±0.1mm)

(Unit:mm)

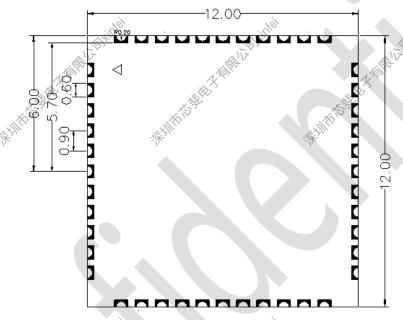


Figure 11-1 XR829MQ Dimensions<TOP VIEW>

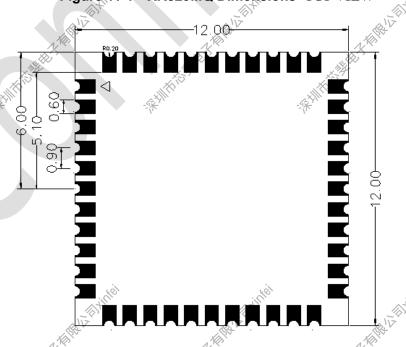


Figure 11-2 XR829MQ Dimensions<Bottom VIEW>



